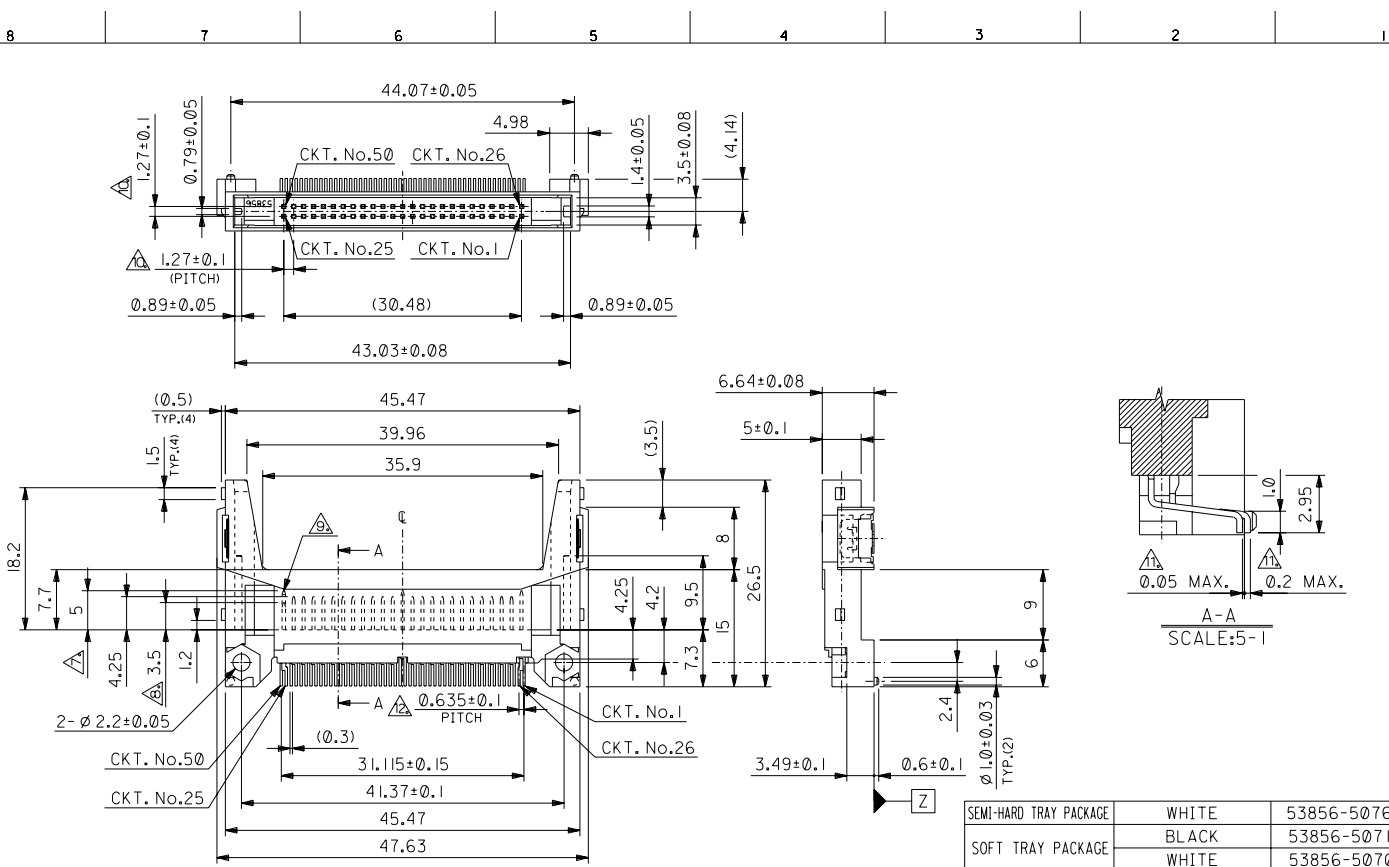


DWG. NO. SD-53856-007



SEMI-HARD TRAY PACKAGE	WHITE	53856-5076	50
SOFT TRAY PACKAGE	BLACK	53856-5071	50
	WHITE	53856-5070	50
PACKING TRAY FORM	HOUSING COLOR MATERIAL No.		No. Of. CKT.

DO NOT SCALE DRAWING	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:

RELEASED	EC NO. J2004-3129	MATERIAL	SEE NOTES
	DRWN: M.NABEI	FINISH	SEE NOTES
	CHK: K.TOJO	WIRE RANGE	
	APPR: M.SASAO	適用電線範囲	
REV	DESCRIPTION	INS. RANGE	
0		適用電線範囲	

GENERAL TOLERANCES: (UNLESS SPECIFIED)	SCALE	DESIGN UNITS
10 UNDER 未満	→	mm <input checked="" type="checkbox"/> INCH <input type="checkbox"/>
10 OVER 以上		
30 UNDER 未満		
30 OVER 以上		
ANGLE 角度		

53856-507*	MODEL No.	DIMENSIONS:	SHT	REV
		<input type="checkbox"/> mm <input type="checkbox"/> INCH <input checked="" type="checkbox"/> mm ONLY		
		THIRD ANGLE PROJECTION		
	TITLE:			
	CF CARD CONN. 50P HEADER ASS'Y -LEAD FREE-			
	MOLEX INCORPORATED			
CAD FILENAME	MATERIAL NO.	DRAWING NO.	SHEET NO.	
SD-53856-007.S01	SEE CHART	SD-53856-007	1 OF 2	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.			SIZE	B

EN-02J(097) MXJ-54

DWG. NO. SD-53856-007

8 7 6 5 4 3 2 1

注) NOTES

1. 材質
 MATERIAL
 ハウジング: ガラス入りLCP UL94V-0
 HOUSING: LCP G.F. UL94V-0
 ピン : リン青銅
 PIN: PHOSPHOR BRONZE
 ネール : リン青銅
 NAIL: PHOSPHOR BRONZE

2. メッキ仕様
 PLATING
 PIN 接点部 : ニッケル下地, パラジウムニッケル, 金メッキ
 CONTACT AREA: PALLADIUM-NICKEL, GOLD OVER NICKEL
 半田付け部: 錫メッキ
 SOLDER TAIL AREA: TIN
 下地メッキ: ニッケルメッキ
 UNDERPLATING: NICKEL OVER ALL
 NAIL 錫メッキ
 TIN
 下地メッキ: ニッケルメッキ
 UNDERPLATING: NICKEL OVER ALL

3. 推奨基板厚 : t \geq 0.8 MIN.
 RECOMMENDED P.C.B. THICKNESS: t \geq 0.8 MIN.

4. 適合カード厚
 RECOMMENDED CARD THICKNESS
 接続部: 3.3 \pm 0.1
 CONNECTING AREA: 3.3 \pm 0.1

5. 適合カード幅: 42.8 \pm 0.1
 RECOMMENDED CARD WIDTH: 42.8 \pm 0.1

6. ハウジング色:
 HOUSING COLOR:
 53856-5010: 白 (WHITE)
 53856-5010: 黒 (BLACK)

寸法適用極: 1,13,38,50
 THIS DIMENSION APPLIES TO CIRCUIT NUMBERS 1,13,38 AND 50.

寸法適用極: 25,26
 THIS DIMENSION APPLIES TO CIRCUIT NUMBERS 25 AND 26.

ピンの倒れは、ピン根元を基準に全方向へ ϕ .1 MAX.とする。
 PIN TIP LEAN TOWARD ANY DIRECTION NOT TO EXCEED ϕ .1 WHEN MEASURED FROM PIN BASE.

ピン根元に適用する。
 THIS DIMENSION TO BE MEASURED AT PIN BASE.

基板推奨寸法
 RECOMMENDED P.C.B. LAYOUT

DO NOT SCALE DRAWING					53856-507*		MODEL NO.		DIMENSIONS:		SHT	REV
					SCALE		DESIGN UNITS		THIRD ANGLE PROJECTION		REVISE ON CAD ONLY	
MATERIAL 材料					10 UNDER 未満		DRAWN BY & DATE M.NABEI '04/03/16		TITLE: CF CARD CONN. 50P HEADER ASS'Y -LEAD FREE-		SHEET NO. 2	
FINISH 仕上げ					10 OVER 30 UNDER 未満		CHECKED BY & DATE K.TOJO '04/03/16					
WIRE RANGE 適用電線範囲					30 OVER 以上		APPROVED BY & DATE H. Saito '04/03/16					
INS. RANGE 被覆外径					ANGLE 角度		CAD FILENAME SD-53856-007.S02		MATERIAL NO.		DRAWING NO. SD-53856-007	
											EN-02J(097) MXJ-54	